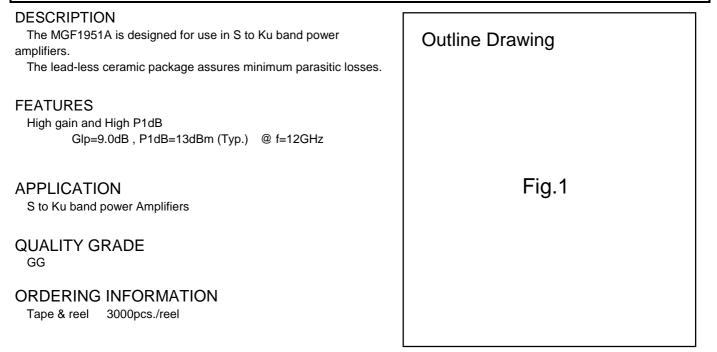
$\label{eq:missingless} \begin{array}{l} \mbox{MITSUBISHI SEMICONDUCTOR} < \mbox{GaAs FET} \\ \mbox{MGF1951A} \end{array}$

Microwave Power MES FET (Leadless Ceramic Package)



ABSOLUTE MAXIMUM RATINGS (Ta=25°C)

Symbol	Parameter	Ratings	Unit			
V _{GDO}	Gate to drain voltage	-8	V			
V _{GSO}	Gate to source voltage	-8	V			
ID	Drain current	120	mA			
PT	Total power dissipation	300	mW			
T _{ch}	Channel temperature	125	°C			
T _{stg}	Storage temperature	-65 to +125	°C			

Keep Safety first in your circuit designs! Mitsubishi Electric Corporation puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage. Remember to give due consideration to safety when making your circuit designs, with appropriate measure such as (I) placement of substitutive, auxiliary circuits, (ii) use of non-flammable material or (iii) prevention against any malfunction or mishap.

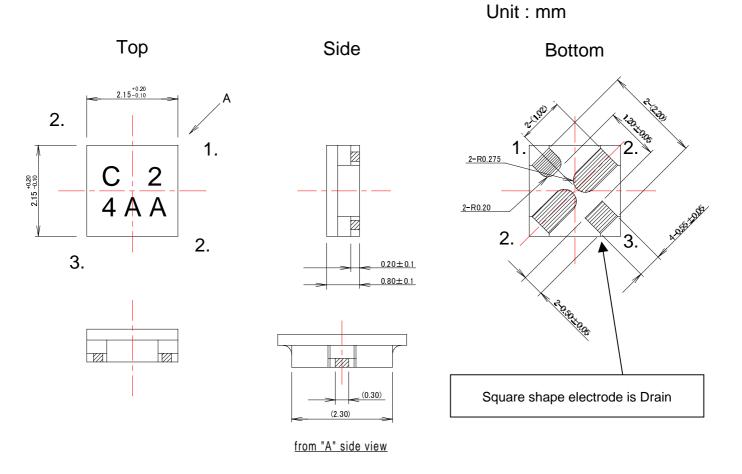
ELECTRICAL CHARACTERISTICS (Ta=25°C)

Synbol	Parameter	Test conditions	Limits		Unit	
			MIN.	TYP.	MAX	
V(BR)GDO	Gate to drain breakdown voltage	Ig=-30μA	-8	-15		V
IDSS	Saturated drain current	V _{GS} =0V,V _{DS} =3V	35	60	120	mA
V _{GS(off)}	Gate to source cut-off voltage	V _{DS} =3V,I _D =300μA	-0.3	-1.4	-3.5	V
P1dB	Output Power at 1dB gain	VDS=3V,ID=30mA	11	13		dBm
	Compression	f=12GHz				
Glp	Linear Power Gain	V _{DS} =3V,ID=30mA	7	9		dB
		f=12GHz,Pin=-5dBm				

MITSUBISHI SEMICONDUCTOR <GaAs FET> MGF1951A

Microwave Power MES FET (Leadless Ceramic Package)

Fig.1



Gate
Source
Drain

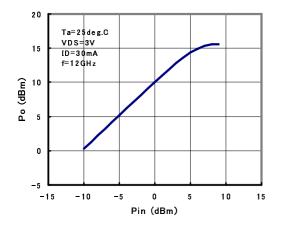
MITSUBISHI

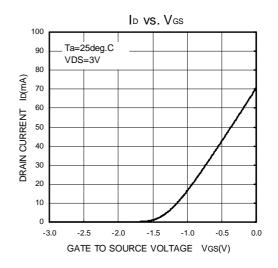
$\label{eq:mitsubishi} \begin{array}{l} \mbox{Mitsubishi semiconductor <GaAs Fets} \\ MGF1951A \end{array}$

Microwave Power MES FET (Leadless Ceramic Package)

ID VS. VDS 100 Ta=25deg.C VGS=-0.2V/STEP 90 80 DRAIN CURRENT ID(mA) VGS=0V 70 60 50 40 30 20 10 0 0.0 1.0 2.0 3.0 4.0 5.0 DRAIN TO SOURCE VOLTAGE VDS(V)







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TYPICAL CHARACTERISTICS (Ta=25°C)

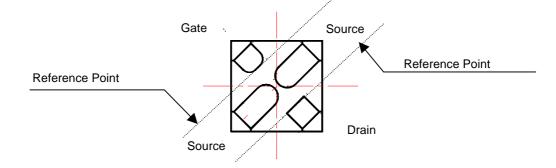
$\label{eq:mitsubishi} \begin{array}{l} \mbox{Mitsubishi semiconductor <GaAs Fets} \\ MGF1951A \end{array}$

Microwave Power MES FET (Leadless Ceramic Package)

S PARAMETERS

					Conditi		/3=3V,IL)=30mA,	Ta=250	ey.c)
f	S11		S	21	S12		S22		K	MAG/MSG
(GHz)	Mag.	Angle	Mag.	Angle	Mag.	Angle	Mag.	Angle		(dB)
1	0.984	-17.7	4.239	163.2	0.016	78.2	0.581	-11.3	0.18	24.3
2	0.946	-38.6	4.103	144.3	0.031	64.3	0.565	-26.2	0.32	21.3
3	0.906	-52.5	3.914	131.2	0.043	54.3	0.548	-34.3	0.43	19.6
4	0.857	-71.1	3.710	115.9	0.054	44.2	0.518	-45.5	0.53	18.4
5	0.811	-85.3	3.445	103.3	0.061	35.6	0.509	-54.9	0.64	17.5
6	0.771	-97.4	3.197	92.5	0.065	29.6	0.500	-61.4	0.76	16.9
7	0.736	-109.8	2.984	81.7	0.069	23.7	0.502	-66.9	0.86	16.4
8	0.710	-121.6	2.847	70.7	0.071	19.0	0.507	-72.1	0.93	16.0
9	0.679	-133.6	2.737	60.4	0.075	15.1	0.509	-75.9	0.99	15.6
10	0.645	-146.3	2.659	20.1	0.083	11.3	0.513	-79.6	0.99	15.1
11	0.594	-159.8	2.600	39.5	0.089	2.6	0.496	-84.2	1.09	12.8
12	0.549	-175.7	2.570	28.4	0.091	-2.7	0.472	-87.2	1.19	11.9
13	0.508	165.8	2.532	16.2	0.095	-9.0	0.443	-91.4	1.27	11.1
14	0.481	142.3	2.480	2.5	0.100	-18.0	0.399	-96.7	1.34	10.5
15	0.472	116.9	2.378	-10.9	0.101	-26.7	0.342	-101.7	1.45	9.7
16	0.508	92.7	2.289	-23.8	0.103	-34.7	0.279	-107.6	1.47	9.4
17	0.573	70.4	2.160	-37.5	0.105	-42.9	0.211	-112.1	1.44	9.2
18	0.646	52.2	1.975	-51.6	0.103	-50.4	0.135	-115.3	1.44	8.9

(Conditions : VDS=3V,ID=30mA,Ta=25deg.C)



MITSUBISHI

$\label{eq:mitsubishi} \begin{array}{l} \mbox{Mitsubishi semiconductor <GaAs fets} \\ MGF1951A \end{array}$

Microwave Power MES FET (Leadless Ceramic Package)

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